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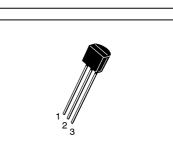




• This device is available in Pb-free package(s). Specifications herein apply to both standard and Pb-free devices. Please see our website at www.onsemi.com for specific Pb-free orderable part numbers, or contact your local ON Semiconductor sales office or representative.

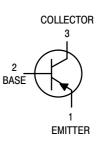
#### **MAXIMUM RATINGS**

| Rating  | Symbol               | Value       | Unit           |  |
|---|----------------------|-------------|----------------|--|
| Collector – Emitter Voltage   | V <sub>CEO</sub>     | -25         | Vdc            |  |
| Collector – Emitter Voltage   | V <sub>CES</sub>     | -25         | Vdc            |  |
| Collector – Base Voltage  | V <sub>CBO</sub>     | -25         | Vdc            |  |
| Emitter – Base Voltage  | V <sub>EBO</sub>     | -4.0        | Vdc            |  |
| Collector Current — Continuous  | Ι <sub>C</sub>       | -500        | mAdc           |  |
| Total Device Dissipation @ T <sub>A</sub> = 25°C<br>Derate above 25°C | PD                   | 625<br>5.0  | mW<br>mW/°C    |  |
| Total Device Dissipation @ T <sub>C</sub> = 25°C<br>Derate above 25°C | PD                   | 1.5<br>12   | Watts<br>mW/°C |  |
| Operating and Storage Junction<br>Temperature Range                   | TJ, T <sub>stg</sub> | -55 to +150 | °C             |  |



**MPS3638A** 

CASE 29-11, STYLE 1 TO-92 (TO-226AA)



#### THERMAL CHARACTERISTICS

| Characteristic                          | Symbol                | Max  | Unit |
|---|-----------------------|------|------|
| Thermal Resistance, Junction to Ambient | $R_{\theta JA}^{(1)}$ | 200  | °C/W |
| Thermal Resistance, Junction to Case    | $R_{\theta JC}$       | 83.3 | °C/W |

#### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

| Characteristic  | Symbol                | Min  | Max            | Unit |
|---|-----------------------|------|----------------|------|
| OFF CHARACTERISTICS   |                       |      |                |      |
| Collector – Emitter Breakdown Voltage $(I_{C} = -100 \ \mu Adc, V_{BE} = 0)$  | V <sub>(BR)CES</sub>  | -25  | _              | Vdc  |
| Collector – Emitter Sustaining Voltage <sup>(2)</sup><br>( $I_{C} = -10$ mAdc, $I_{B} = 0$ )  | V <sub>CEO(sus)</sub> | -25  |                | Vdc  |
| Collector – Base Breakdown Voltage $(I_{C} = -100 \ \mu Adc, I_{E} = 0)$  | V <sub>(BR)CBO</sub>  | -25  |                | Vdc  |
| Emitter – Base Breakdown Voltage $(I_E = -100 \ \mu Adc, I_C = 0)$  | V <sub>(BR)EBO</sub>  | -4.0 |                | Vdc  |
| Collector Cutoff Current<br>$(V_{CE} = -15 \text{ Vdc}, V_{BE} = 0)$<br>$(V_{CE} = -15 \text{ Vdc}, V_{BE} = 0, T_A = -65^{\circ}\text{C})$ | ICES                  |      | -0.035<br>-2.0 | μAdc |
| Emitter Cutoff Current<br>( $V_{EB} = -3.0 \text{ V}, I_C = 0$ )  | I <sub>EBO</sub>      | —    | -35            | nA   |
| Base Current<br>(V <sub>CE</sub> = -15 Vdc, V <sub>BE</sub> = 0)  | Ι <sub>Β</sub>        |      | -0.035         | μAdc |

1.  $R_{\theta JA}$  is measured with the device soldered into a typical printed circuit board.

2. Pulse Test: Pulse Width  $\leq$  300 µs; Duty Cycle  $\leq$  2.0%.

| ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = | 25°C unless otherwise noted) (Continued) |
|--|--|
|--|--|

|   | Symbol  | Min                    | Max   | Unit               |     |
|---|---|------------------------|-------|--------------------|-----|
| ON CHARACTE   | RISTICS <sup>(2)</sup>  |                        |       |                    |     |
| DC Current Gain<br>( $I_C = -1.0$ mAdc<br>( $I_C = -10$ mAdc,<br>( $I_C = -50$ mAdc,<br>( $I_C = -300$ mAdc | h <sub>FE</sub>   | 80<br>100<br>100<br>20 | <br>  | _                  |     |
| (I <sub>C</sub> = −50 mAdc,   | Saturation Voltage<br>$I_B = -2.5 \text{ mAdc}$ )<br>c, $I_B = -30 \text{ mAdc}$ )  | V <sub>CE(sat)</sub>   |       | -0.25<br>-1.0      | Vdc |
|   | uration Voltage<br>I <sub>B</sub> = -2.5 mAdc)<br>c, I <sub>B</sub> = -30 mAdc)     | V <sub>BE(sat)</sub>   | -0.80 | -1.1<br>-2.0       | Vdc |
| SMALL-SIGNAL  | _ CHARACTERISTICS   |                        |       |                    |     |
| Current-Gain — E<br>(V <sub>CE</sub> = -3.0 Vdc   | f <sub>T</sub>  | 150                    | _     | MHz                |     |
| Output Capacitand<br>(V <sub>CB</sub> = -10 Vdc   | C <sub>obo</sub>  | _                      | 10    | pF                 |     |
| Input Capacitance<br>(V <sub>EB</sub> = -0.5 Vdc, I <sub>C</sub> = 0, f = 1.0 MHz)                          |   | C <sub>ibo</sub>       |       | 25                 | pF  |
| Input Impedance<br>(I <sub>C</sub> = -10 mAdc,  | V <sub>CE</sub> = -10 Vdc, f = 1.0 kHz)   | h <sub>ie</sub>        |       | 2000               | kΩ  |
| Voltage Feedback<br>(I <sub>C</sub> = -10 mAdc,   | h <sub>re</sub>   |                        | 15    | X 10 <sup>-4</sup> |     |
| Small-Signal Curr<br>(I <sub>C</sub> = -10 mAdc,  | h <sub>fe</sub>   | 100                    |       | _                  |     |
| Output Admittance $(I_{\rm C} = -10 \text{ mAdc},$  | h <sub>oe</sub>   | _                      | 1.2   | mmhos              |     |
| SWITCHING CH  | ARACTERISTICS   | ·                      |       |                    |     |
| Delay Time  | (V <sub>CC</sub> = -10 Vdc, I <sub>C</sub> = -300 mAdc, I <sub>B1</sub> = -30 mAdc) | t <sub>d</sub>         | _     | 20                 | ns  |
| Rise Time   | $(v_{CC} = -10, v_{CC}, 1C = -300, 11Mac, 1B1 = -30, 11Mac)$                        | tr                     | —     | 70                 | ns  |
| Storage Time  | $(V_{CC} = -10 \text{ Vdc}, I_C = -300 \text{ mAdc},$                               | t <sub>s</sub>         |       | 140                | ns  |
| Fall Time   | $I_{B1} = -30 \text{ mAdc}, I_{B2} = -30 \text{ mAdc})$                             | t <sub>f</sub>         | —     | 70                 | ns  |
| Turn-On Time  | (I <sub>C</sub> = -300 mAdc, I <sub>B1</sub> = -30 mAdc)                            | t <sub>on</sub>        | —     | 75                 | ns  |
|   |   |                        |       |                    |     |

170

t<sub>off</sub>

ns

2. Pulse Test: Pulse Width  $\leq$  300  $\mu s;$  Duty Cycle  $\leq$  2.0%.

 $(I_{C} = -300 \text{ mAdc}, I_{B1} = -30 \text{ mAdc}, I_{B2} = 30 \text{ mAdc})$ 

Turn-Off Time

# SWITCHING TIME EQUIVALENT TEST CIRCUIT

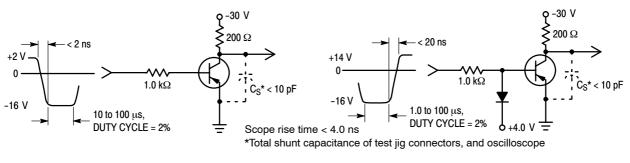


Figure 1. Turn-On Time

Figure 2. Turn-Off Time



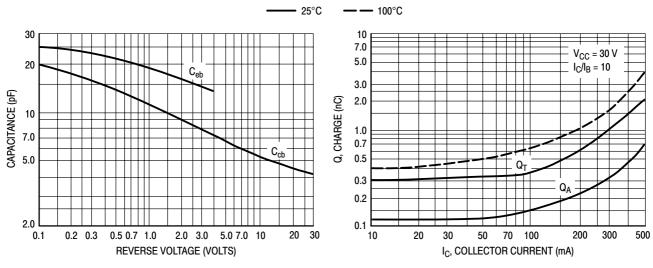


Figure 3. Capacitances

Figure 4. Charge Data

# TRANSIENT CHARACTERISTICS (Continued)

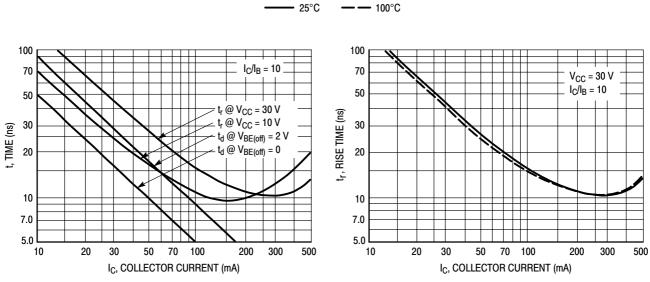


Figure 5. Turn-On Time

Figure 6. Rise Time

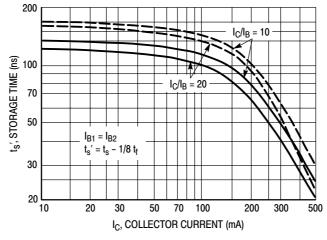


Figure 7. Storage Time

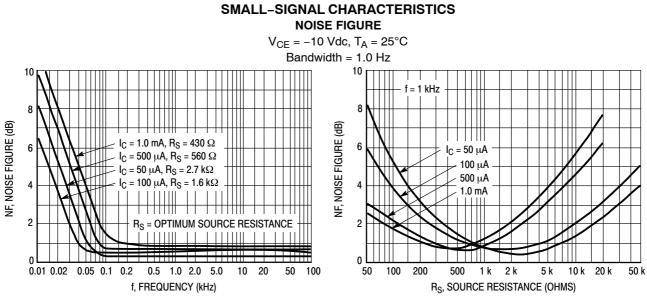




Figure 9. Source Resistance Effects

## h PARAMETERS

#### $V_{CE} = -10 \text{ Vdc}, \text{ f} = 1.0 \text{ kHz}, \text{ T}_{A} = 25^{\circ}\text{C}$

This group of graphs illustrates the relationship between  $h_{fe}$  and other "h" parameters for this series of transistors. To obtain these curves, a high-gain and a low-gain unit were

selected from the 2N4402 line, and the same units were used to develop the correspondingly-numbered curves on each graph.

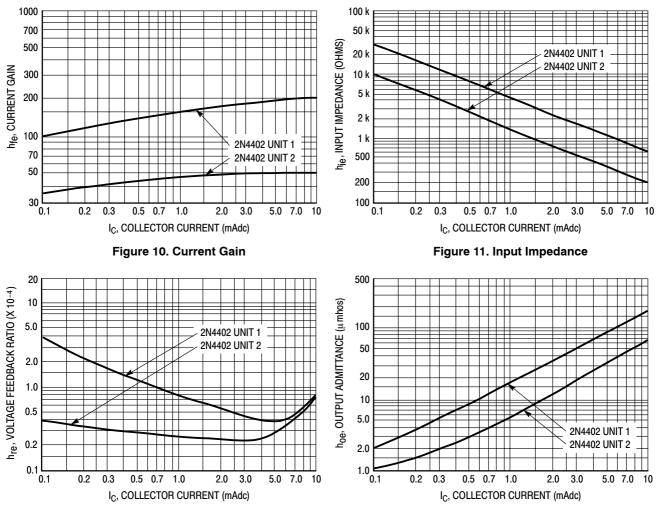
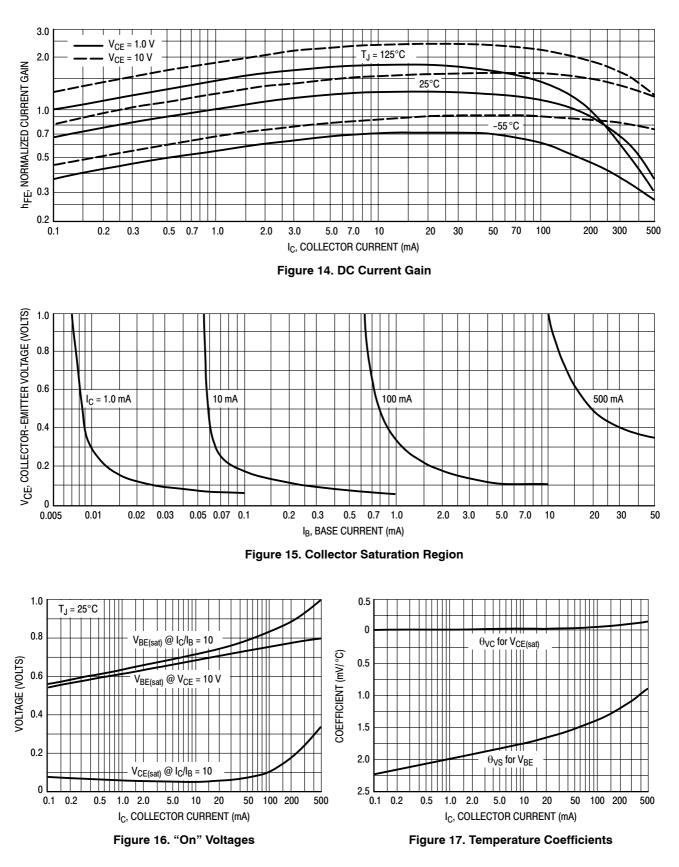


Figure 12. Voltage Feedback Ratio

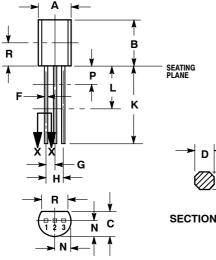
Figure 13. Output Admittance

### STATIC CHARACTERISTICS



#### PACKAGE DIMENSIONS

CASE 029-11 (TO-226AA) ISSUE AD







STYLE 1: PIN 1. EMITTER 2. BASE 3. COLLECTOR

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI
- CONTROLLING DIMENSION: INCH.
  CONTROLLING DIMENSION: INCH.
  CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED. 4. DIMENSION F APPLIES BETWEEN P AND L.
- DIMENSIONS D AND J APPLY BETWEEN L AND K MIMIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

|     | INCHES |       | MILLIMETERS |       |
|-----|--------|-------|-------------|-------|
| DIM | MIN    | MAX   | MIN         | MAX   |
| Α   | 0.175  | 0.205 | 4.44        | 5.21  |
| В   | 0.290  | 0.310 | 7.37        | 7.87  |
| C   | 0.125  | 0.165 | 3.18        | 4.19  |
| D   | 0.018  | 0.021 | 0.457       | 0.533 |
| F   | 0.016  | 0.019 | 0.407       | 0.482 |
| G   | 0.045  | 0.055 | 1.15        | 1.39  |
| Н   | 0.095  | 0.105 | 2.42        | 2.66  |
| J   | 0.018  | 0.024 | 0.46        | 0.61  |
| K   | 0.500  |       | 12.70       |       |
| L   | 0.250  |       | 6.35        |       |
| N   | 0.080  | 0.105 | 2.04        | 2.66  |
| Р   |        | 0.100 |             | 2.54  |
| R   | 0.135  |       | 3.43        |       |

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